

Description

The FDD6685 uses advanced trench technology to provide excellent R_{DS(ON)}, low gate charge and operation with gate voltages as low as 4.5V. This device is suitable for use as a Battery protection or in other Switching application.



TO-252-2L

General Features

 $V_{DS} = -30V I_{D} = 50 A$

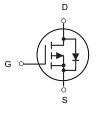
 $R_{DS(ON)}$ < 18m Ω @ V_{GS} =10V

Application

Battery protection

Load switch

Uninterruptible power supply



P-Channel MOSFET

Package Marking and Ordering Information

Product ID	Pack	Brand	Qty(PCS)
FDD6685	TO-252-2L	HXY MOSFET	2500

Absolute Maximum Ratings (T_C=25°Cunless otherwise noted)

Symbol	Symbol Parameter		Units	
VDS	Drain-Source Voltage	-30	V	
Vgs	Gate-Source Voltage ±25		V	
I _D @T _C =25°C	Continuous Drain Current, V _{GS} @ -10V ¹	-50	А	
I _D @T _C =100°C	Continuous Drain Current, V _{GS} @ -10V ¹	-32	А	
I _D @T _A =25°C	Continuous Drain Current, V _{GS} @ -10V ¹	-9.6	А	
I _D @T _A =70°C	Continuous Drain Current, V _{GS} @ -10V ¹	-7.7	А	
Ірм	Pulsed Drain Current ²	-150	А	
EAS	Single Pulse Avalanche Energy ³	125	mJ	
las	Avalanche Current	-50	А	
P _D @T _C =25°C	Total Power Dissipation ⁴ 45		W	
P _D @T _A =25°C	Total Power Dissipation ⁴ 2		W	
Тѕтс	Storage Temperature Range -55 to 150		°C	
TJ	Operating Junction Temperature Range -55 to 150		°C	
Reja	Thermal Resistance Junction-Ambient ¹ 62		°C/W	
Rejc	Thermal Resistance Junction-Case ¹	2.8	°C/W	



Electrical Characteristics (T_J=25 °C, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit	
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V , I _D =-250uA	-30			V	
$\triangle BV_{DSS}/\triangle T$	BVDSS Temperature Coefficient	Reference to 25°C , I _D =-1mA	I	-0.0232	-	V/°C	
Б	Static Drain-Source On-Resistance ²	V _{GS} =-10V , I _D =-30A	=-10V , I _D =-30A 15		18	mO	
R _{DS(ON)}	Static Dialii-Source On-Resistance	V _{GS} =-4.5V , I _D =-15A		24	32	mΩ	
V _{GS(th)}	Gate Threshold Voltage	V _{GS} =V _{DS} , I _D =-250uA	-1.0		-2.5	V	
$\triangle V_{GS(th)}$	V _{GS(th)} Temperature Coefficient	VGS-VDS , ID250UA		4.6		mV/°C	
lana	Danier Course Lookers Course	V _{DS} =-24V , V _{GS} =0V , T _J =25°C			-1		
I _{DSS}	Drain-Source Leakage Current	V _{DS} =-24V , V _{GS} =0V , T _J =55°C		-5	uA		
I _{GSS}	Gate-Source Leakage Current	$V_{GS}=\pm 25V$, $V_{DS}=0V$			±100	nA	
gfs	Forward Transconductance	V _{DS} =-5V , I _D =-30A		30		S	
Rg	Gate Resistance	V _{DS} =0V , V _{GS} =0V , f=1MHz		9		Ω	
Qg	Total Gate Charge (-4.5V)			22			
Qgs	Gate-Source Charge	V _{DS} =-15V , V _{GS} =-4.5V , I _D =-15A		8.7		nC	
Q _{gd}	Gate-Drain Charge			7.2			
T _{d(on)}	Turn-On Delay Time			8			
Tr	Rise Time	V_{DD} =-15V , V_{GS} =-10V , R_{G} =3.3 Ω		73.7		ns	
T _{d(off)}	Turn-Off Delay Time	I _D =-15A		61.8			
Tf	Fall Time			24.4			
C _{iss}	Input Capacitance			2215			
Coss	Output Capacitance	V _{DS} =-15V , V _{GS} =0V , f=1MHz		310		pF	
C _{rss}	Reverse Transfer Capacitance			237			
Is	Continuous Source Current ^{1,5}	\/-=\/-=0\/ Force Current			-50	Α	
Isм	Pulsed Source Current ^{2,5}	V _G =V _D =0V , Force Current			-150	Α	
V _{SD}	Diode Forward Voltage ²	V _{GS} =0V , I _S =-1A , T _J =25°C			-1	V	
t _{rr}	Reverse Recovery Time	IF=-15A , dI/dt=100A/μs ,		19	-	nS	
Qrr	Reverse Recovery Charge	T _J =25°C		9		nC	

Note:

^{1.} The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper.

^{2.}The data tested by pulsed , pulse width $\,\leq\,300\text{us}$, duty cycle $\,\leq\,2\%$

^{3.} The EAS data shows Max. rating . The test condition is V_{DD} =-25V, V_{GS} =-10V,L=0.1mH, I_{AS} =-50A

^{4.} The power dissipation is limited by 150°C junction temperature

^{5.} The data is theoretically the same as I_D and I_{DM} , in real applications, should be limited by total power dissipation.



Typical Characteristics

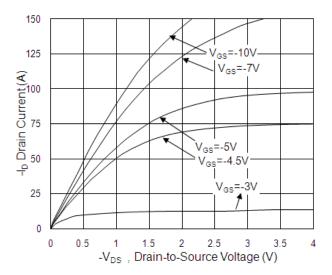


Fig.1 Typical Output Characteristics

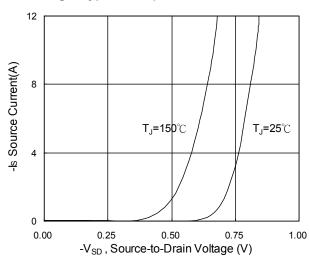


Fig.3 Forward Characteristics of Reverse

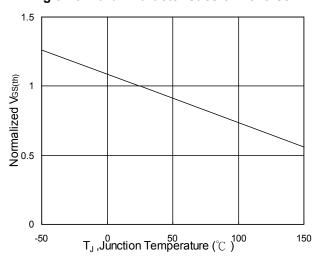


Fig.5 Normalized V_{GS(th)} vs. T_J

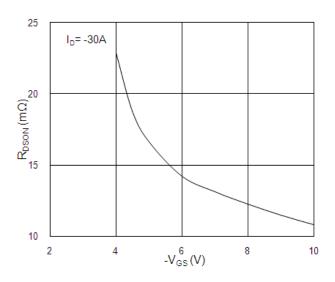


Fig.2 On-Resistance vs. G-S Voltage

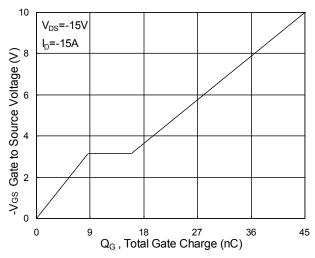


Fig.4 Gate-charge Characteristics

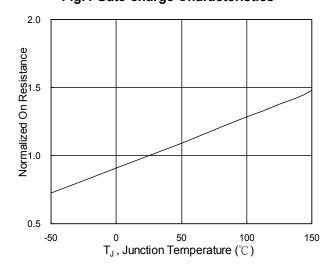
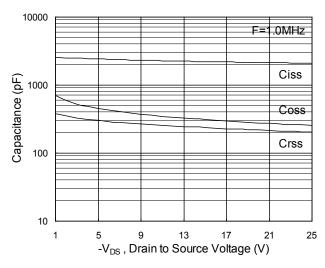


Fig.6 Normalized R_{DSON} vs. T_J





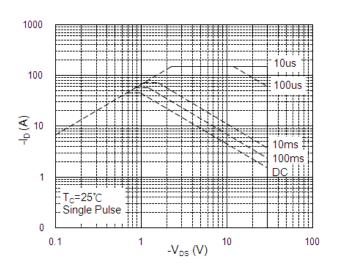


Fig.7 Capacitance

Fig.8 Safe Operating Area

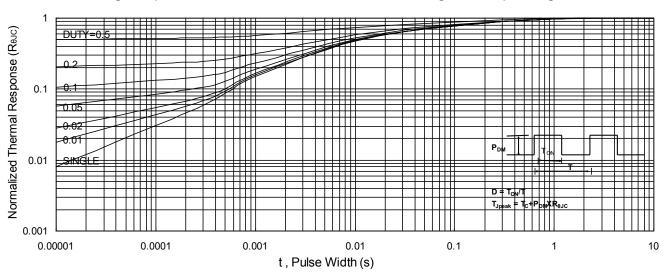


Fig.9 Normalized Maximum Transient Thermal Impedance

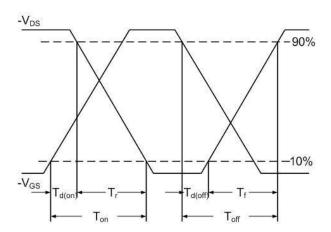


Fig.10 Switching Time Waveform

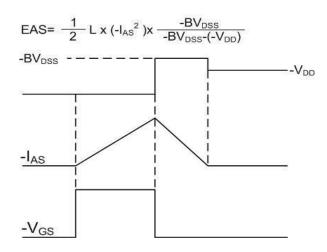
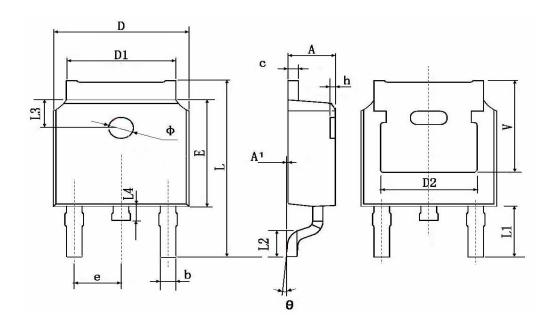


Fig.11 Unclamped Inductive Switching Waveform



TO-252-2L Package Information



Dimensions In Millimeters		Dimensions In Inches		
Min.	Max.	Min.	Max.	
2.200	2.400	0.087	0.094	
0.000	0.127	0.000	0.005	
0.660	0.860	0.026	0.034	
0.460	0.580	0.018	0.023	
6.500	6.700	0.256	0.264	
5.100	5.460	0.201	0.215	
4.830 TYP.		0.190 TYP.		
6.000	6.200	0.236	0.244	
2.186	2.386	0.086	0.094	
9.800	10.400	0.386	0.409	
2.900 TYP.		0.114 TYP.		
1.400	1.700	0.055	0.067	
1.600 TYP.		0.063 TYP.		
0.600	1.000	0.024	0.039	
1.100	1.300	0.043	0.051	
0°	8°	0°	8°	
0.000	0.300	0.000	0.012	
5.350 TYP.		0.211 TYP.		
	Min. 2.200 0.000 0.660 0.460 6.500 5.100 4.830 6.000 2.186 9.800 2.900 1.400 1.600 0.600 1.100 0° 0.000	Min. Max. 2.200 2.400 0.000 0.127 0.660 0.860 0.460 0.580 6.500 6.700 5.100 5.460 4.830 TYP. 6.200 2.186 2.386 9.800 10.400 2.900 TYP. 1.700 1.600 TYP. 0.600 1.100 1.300 0° 8° 0.000 0.300	Min. Max. Min. 2.200 2.400 0.087 0.000 0.127 0.000 0.660 0.860 0.026 0.460 0.580 0.018 6.500 6.700 0.256 5.100 5.460 0.201 4.830 TYP. 0.190 6.000 6.200 0.236 2.186 2.386 0.086 9.800 10.400 0.386 2.900 TYP. 0.114 1.400 1.700 0.055 1.600 TYP. 0.063 0.600 1.000 0.024 1.100 1.300 0.043 0° 8° 0° 0.000 0.300 0.000	



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